

## TIP105/106/107

### Monolithic Construction With Built In Base-Emitter Shunt Resistors

- High DC Current Gain :  $h_{FE}$ =1000 @  $V_{CE}$ = -4V,  $I_{C}$ = -3A (Min.)
- Collector-Emitter Sustaining Voltage
- Low Collector-Emitter Saturation Voltage
- Industrial Use
- Complementary to TIP100/101/102

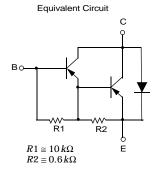


1.Base 2.Collector 3.Emitter

## **PNP Epitaxial Silicon Darlington Transistor**

### Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V <sub>CBO</sub>	Collector-Base Voltage : TIP105	- 60	V	
	: TIP106	- 80	V	
	: TIP107	- 100	V	
V <sub>CEO</sub>	Collector-Emitter Voltage : TIP105	- 60	V	
	: TIP106	- 80	V	
	: TIP107	- 100	V	
V <sub>EBO</sub>	Emitter-Base Voltage	- 5	V	
I <sub>C</sub>	Collector Current (DC)	- 8	Α	
I <sub>CP</sub>	Collector Current (Pulse)	- 15	Α	
I <sub>B</sub>	Base Current (DC)	- 1	Α	
P <sub>C</sub>	Collector Dissipation (T <sub>a</sub> =25°C)	2	W	
	Collector Dissipation (T <sub>C</sub> =25°C)	80	W	
T <sub>J</sub>	Junction Temperature	150	°C	
T <sub>STG</sub>	Storage Temperature	- 65 ~ 150	°C	



## Electrical Characteristics T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
V <sub>CEO</sub> (sus)	Collector-Emitter Sustaining Voltage				
	: TIP105	$I_{C} = -30 \text{mA}, I_{B} = 0$	-60		V
	: TIP106		-80		V
	: TIP107		-100		V
I <sub>CEO</sub>	Collector Cut-off Current				
	: TIP105	$V_{CE} = -30V, I_{B} = 0$		-50	μΑ
	: TIP106	$V_{CE} = -40V, I_{B} = 0$		-50	μA
	: TIP107	$V_{CE} = -50V, I_{B} = 0$		-50	μΑ
I <sub>CBO</sub>	Collector Cut-off Current				
	: TIP105	$V_{CB} = -60V, I_{E} = 0$		-50	μΑ
	: TIP106	$V_{CB} = -80V, I_{E} = 0$		-50	μΑ
	: TIP107	$V_{CB} = -100V, I_{E} = 0$		-50	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{BE} = -5V, I_{C} = 0$		-2	mA
h <sub>FE</sub>	DC Current Gain	$V_{CE} = -4V, I_{C} = -3A$	1000	20000	
		$V_{CE} = -4V, I_{C} = -8A$	200		
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	$I_{C} = -3A, I_{B} = -6mA$		-2	V
		$I_{C} = -8A, I_{B} = -80mA$		-2.5	V
V <sub>BE</sub> (on)	Base-Emitter ON Voltage	$V_{CE} = -4V, I_{C} = -8A$		-2.8	V
C <sub>ob</sub>	Output Capacitance	$V_{CB} = -10V, I_E = 0, f = 0.1MHz$		300	pF

# **Typical Characteristics**

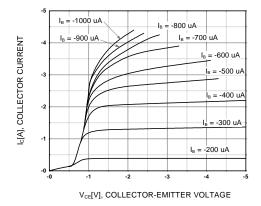


Figure 1. Static Characteristic

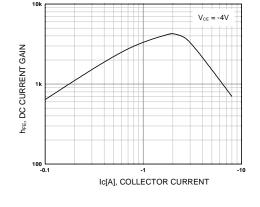


Figure 2. DC current Gain

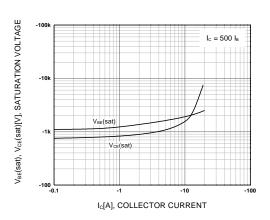


Figure 3. Collector-Emitter Saturation Voltage Base-Emitter Saturation Voltage

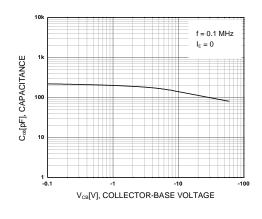


Figure 4. Collector Output Capacitance

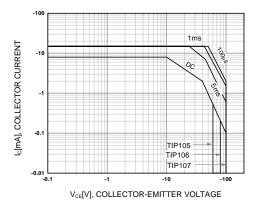


Figure 5. Safe Operating Area

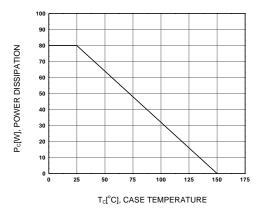
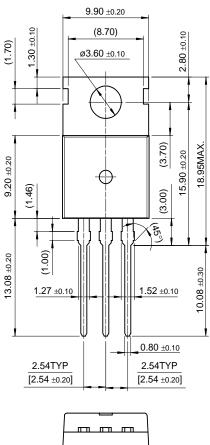


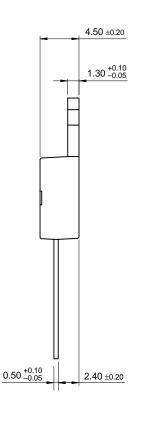
Figure 6. Power Derating

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# **Package Demensions**

TO-220





10.00 ±0.20

Dimensions in Millimeters

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